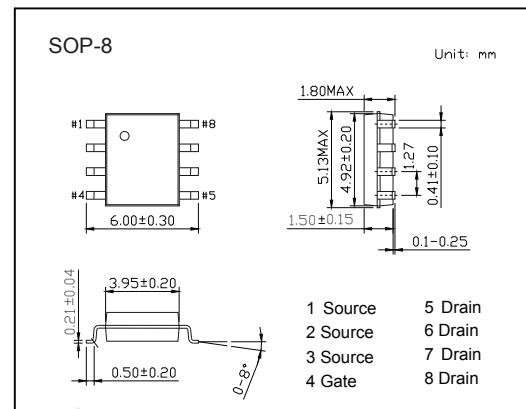
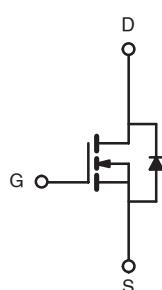


## N-Channel MOSFET

2KK7005

## ■ Features

- $BV_{DSS} = 20\text{ V}$
- $I_D = 25\text{ A}$
- $R_{DS(ON)} < 4\text{ m}\Omega @ V_{GS} = 4.5\text{ V}$
- $R_{DS(ON)} < 6\text{ m}\Omega @ V_{GS} = 2.5\text{ V}$

■ Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	
Continuous Drain Current	$I_D$	25	A
		17.7	
Pulsed Drain Current	$I_{DM}$	140	
Power Dissipation	$P_D$	2.5	W
Thermal Resistance.Junction- to-Ambient (Note 2)	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{Stg}$	-55 to 150	

## N-Channel MOSFET

## 2KK7005

■ Electrical Characteristics ( $T_A = 25^\circ\text{C}$  unless otherwise specified)

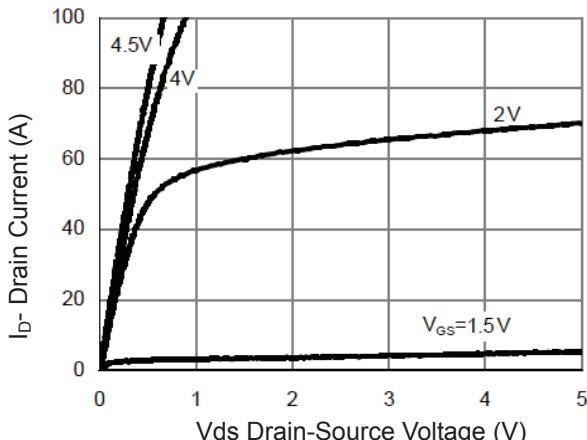
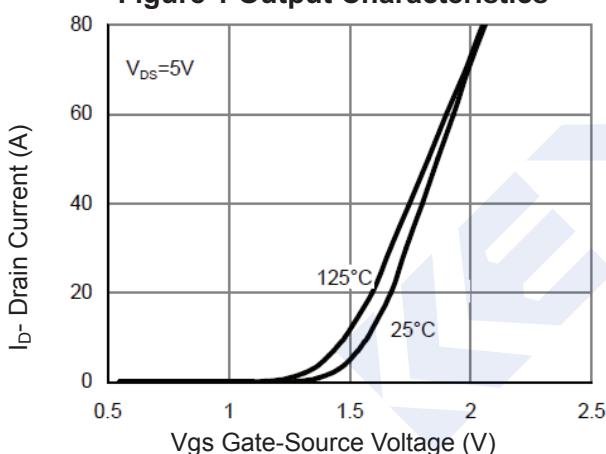
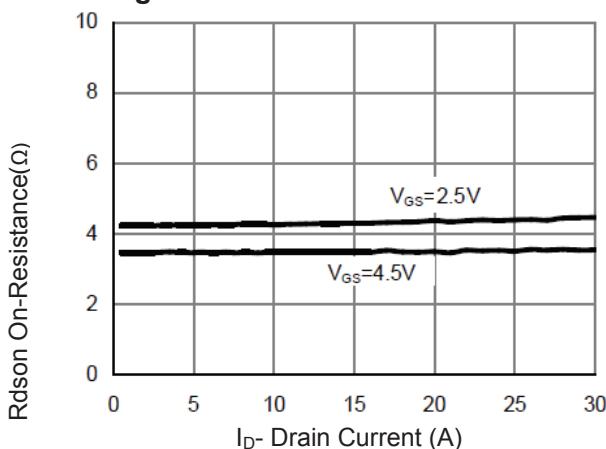
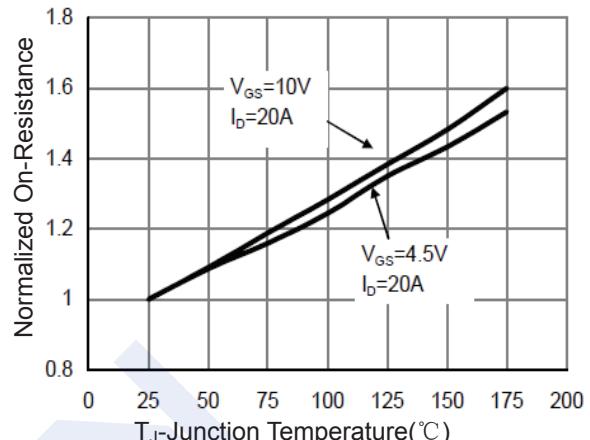
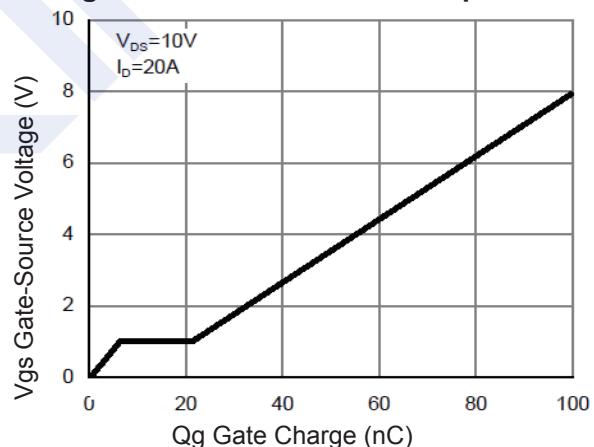
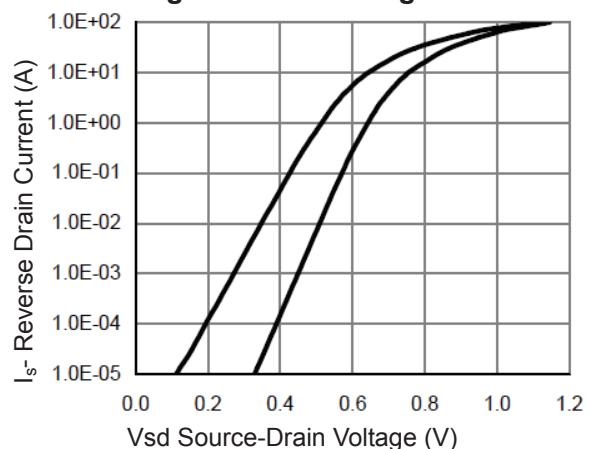
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$I_D = 250 \mu\text{A}, V_{GS} = 0\text{V}$	20			V
Zero Gate Voltage Drain Current	$I_{DS(on)}$	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	$\mu\text{A}$
Gate to Source Leakage Current	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			$\pm 100$	nA
<b>On Characteristics (Note 3)</b>						
Gate to Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	0.5		1.2	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$			4	$\text{m}\Omega$
		$V_{GS} = 2.5 \text{ V}, I_D = 18 \text{ A}$			6	
Forward Transconductance	$g_{FS}$	$V_{DS} = 5 \text{ V}, I_D = 20 \text{ A}$	60			S
<b>Dynamic Characteristics (Note 4)</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 10 \text{ V}, f = 1 \text{ MHz}$		5300		pF
Output Capacitance	$C_{oss}$			785		
Reverse Transfer Capacitance	$C_{rss}$			629		
<b>Switching Characteristics (Note 4)</b>						
Total Gate Charge	$Q_g$	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}, I_D = 20 \text{ A}$		64.9		nC
Gate Source Charge	$Q_{gs}$			6.5		
Gate Drain Charge	$Q_{gd}$			13.8		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}, R_{GEN} = 3 \Omega, R_L = 0.5 \Omega$		10		ns
Turn-On Rise Time	$t_r$			12		
Turn-Off Delay Time	$t_{d(off)}$			50		
Turn-Off Fall Time	$t_f$			20		
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	$V_{SD}$	$V_{GS} = 0 \text{ V}, I_S = 25 \text{ A}$			1.2	V
Diode Forward Current (Note 2)	$I_S$				25	A

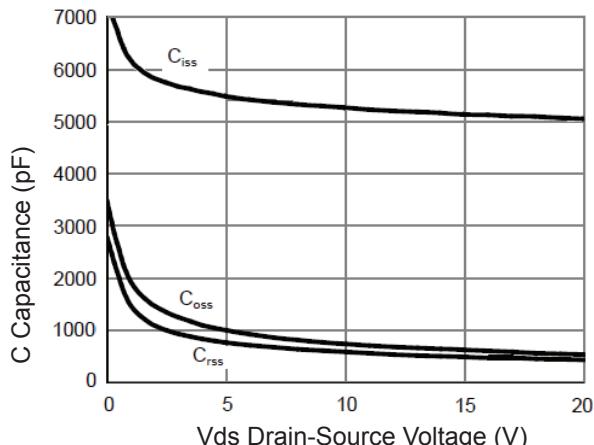
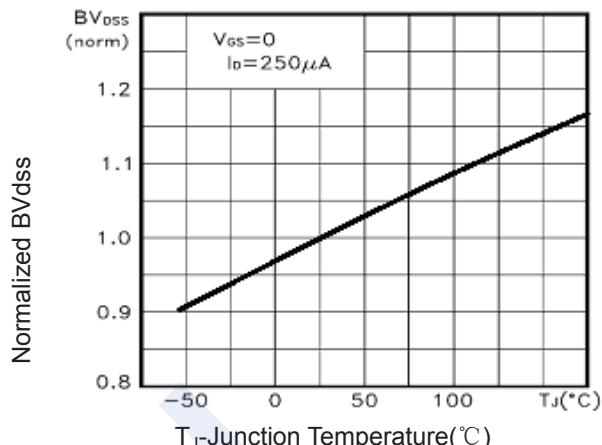
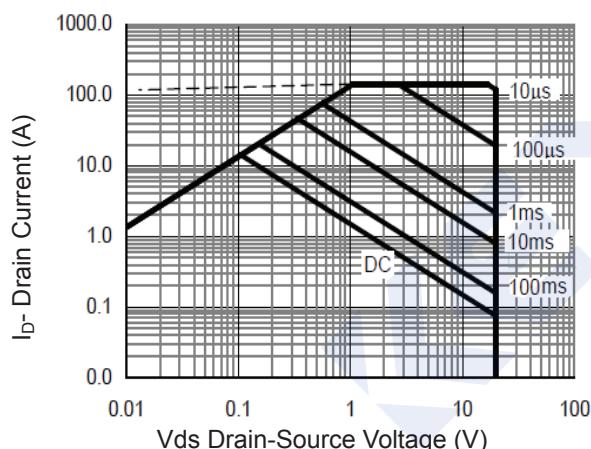
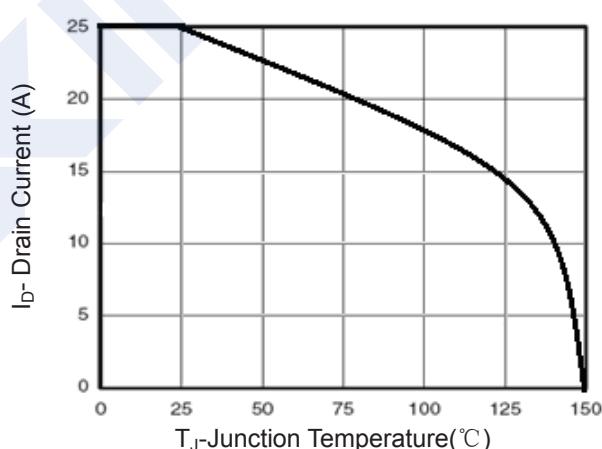
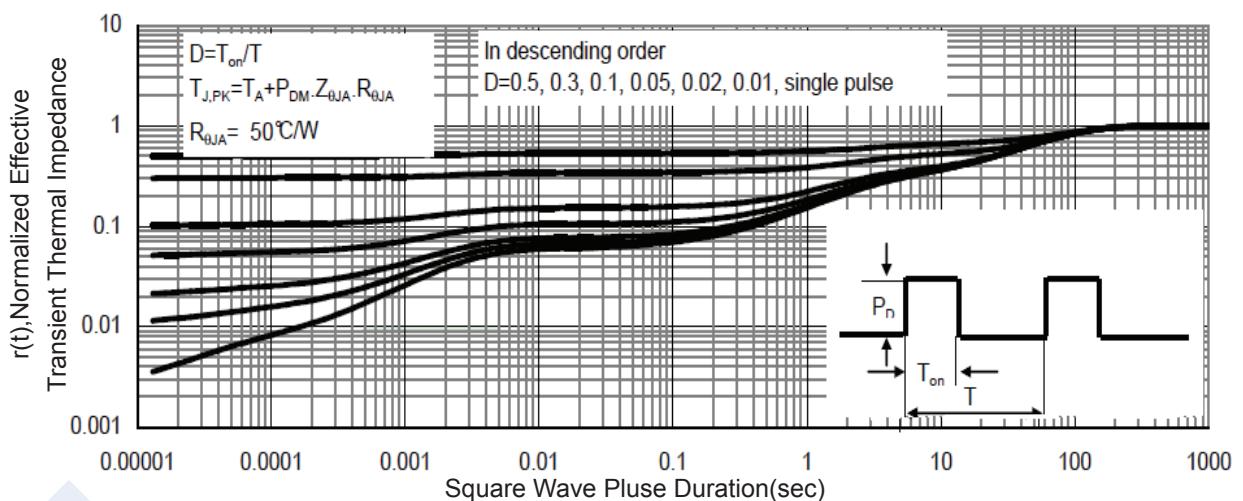
Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10 \text{ sec}$ .
3. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

## ■ Marking

Marking	K7005 KC***
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**N-Channel MOSFET****2KK7005****■ Typical Electrical and Thermal Characteristics****Figure 1 Output Characteristics****Figure 2 Transfer Characteristics****Figure 3 Rdson- Drain Current****Figure 4 Rdson-Junction Temperature****Figure 5 Gate Charge****Figure 6 Source- Drain Diode Forward**

**N-Channel MOSFET****2KK7005****Figure 7 Capacitance vs Vds****Figure 9  $BV_{dss}$  vs Junction Temperature****Figure 8 Safe Operation Area****Figure 10 Current vs Junction Temperature****Figure 11 Normalized Maximum Transient Thermal Impedance**